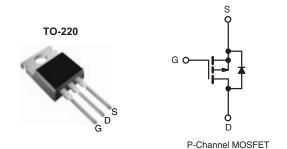


Vishay Siliconix

COMPLIANT

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 200			
R _{DS(on)} (Max.) (Ω)	V _{GS} = - 10 V	0.80		
Q _g (Max.) (nC)	29			
Q _{gs} (nC)	5.4			
Q _{gd} (nC)	15			
Configuration	Single			



FEATURES

- · Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Lead (Pb)-free Available

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free	IRF9630PbF
	SiHF9630-E3
SnPb	IRF9630
	SiHF9630

ABSOLUTE MAXIMUM RATINGS T	_C = 25 °C, u	nless otherw	ise noted			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	- 200		
Gate-Source Voltage			V_{GS}	± 20	_ V	
Continuous Drain Current	V at 10 V	T _C = 25 °C	- I _D	- 6.5		
	V _{GS} at - 10 V	T _C = 100 °C		- 4.0	A	
Pulsed Drain Current ^a			I _{DM}	- 26		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	500	mJ	
Repetitive Avalanche Current ^a			I _{AR}	- 6.4	Α	
Repetitive Avalanche Energy ^a			E _{AR}	7.4	mJ	
Maximum Power Dissipation	T _C =	25 °C	P_{D}	74	W	
Peak Diode Recovery dV/dtc			dV/dt	- 5.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d		
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
			Ī	1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 17 mH, R_G = 25 Ω , I_{AS} = 6.5 A (see fig. 12). c. I_{SD} \leq 6.5 A, dl/dt \leq 120 A/ μ s, V_{DD} \leq V_{DS}, T_J \leq 150 °C. d. 1.6 mm from case.

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^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRF9630, SiHF9630

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.7		

PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0	V, I _D = - 250 μA	- 200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	to 25 °C, I _D = - 1 mA	-	- 0.24	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	_{GS} , I _D = - 250 μA	- 2.0	-	- 4.0	٧
Gate-Source Leakage	I _{GSS}	Vo	_{SS} = ± 20 V	-	-	± 100	nA
Zana Cata Waltana Duain Commant	1	V _{DS} = - 200 V, V _{GS} = 0 V		-	-	- 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 160 V,	V _{GS} = 0 V, T _J = 125 °C	-	-	- 500	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 3.9 A ^b	-	-	0.80	Ω
Forward Transconductance	9 _{fs}	V _{DS} = - 50 V, I _D = - 3.9 A ^b		2.8	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = -25 \text{ V},$ f = 1.0 MHz, see fig. 5		-	700	-	pF
Output Capacitance	C _{oss}			-	200	-	
Reverse Transfer Capacitance	C _{rss}			-	40	-	
Total Gate Charge	Qg		I _D = - 6.5 A,	-	-	29	nC
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	$V_{DS} = -160 \text{ V},$	-	-	5.4	
Gate-Drain Charge	Q _{gd}	7	see fig. 6 and 13 ^b	-	-	15	
Turn-On Delay Time	t _{d(on)}			-	12	-	
Rise Time	t _r	V ₂₂ 1	V _{DD} = - 100 V, I _D = - 6.5 A,		27	-	- ns
Turn-Off Delay Time	t _{d(off)}	$r_{G} = 12 \Omega$, $r_{D} = 15 \Omega$, see fig. 10^{b}		-	28	-	
Fall Time	t _f			-	24	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") fro	Between lead, 6 mm (0.25") from		4.5	-	nU.
Internal Source Inductance	L _S	package and center of die contact		-	7.5	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbo	MOSFET symbol showing the		-	- 6.5	A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	- 26	
Body Diode Voltage	V_{SD}	T _J = 25 °C, I _S	$_{S} = -6.5 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	-	-	- 6.5	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = -6.5 \text{A}, \text{dl/dt} = 100 \text{A/}\mu\text{s}^b$		-	200	300	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	1.9	2.9	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)				L _D)	

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width $\leq 300~\mu s$; duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

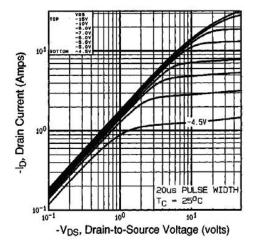


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

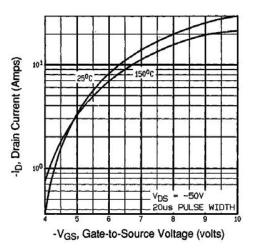


Fig. 3 - Typical Transfer Characteristics

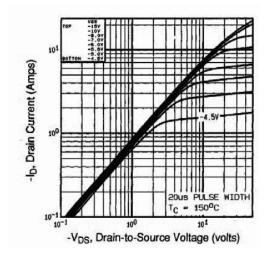


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

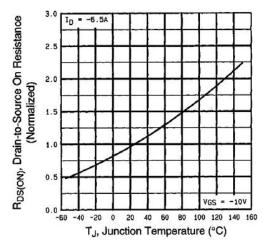


Fig. 4 - Normalized On-Resistance vs. Temperature

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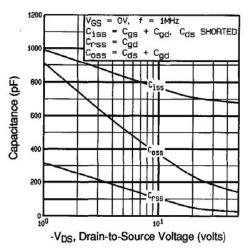


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

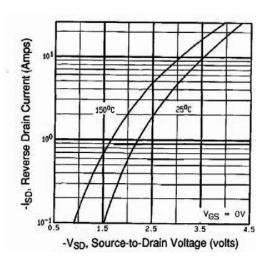


Fig. 7 - Typical Source-Drain Diode Forward Voltage

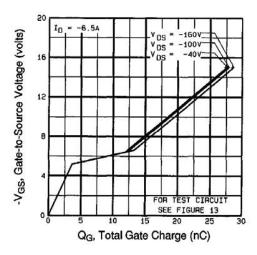


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

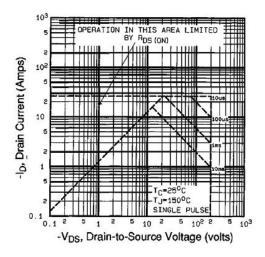


Fig. 8 - Maximum Safe Operating Area





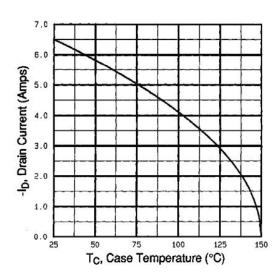


Fig. 9 - Maximum Drain Current vs. Case Temperature

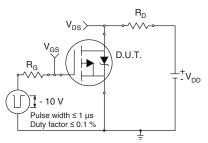


Fig. 10a - Switching Time Test Circuit

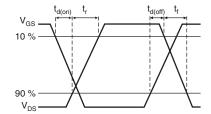


Fig. 10b - Switching Time Waveforms

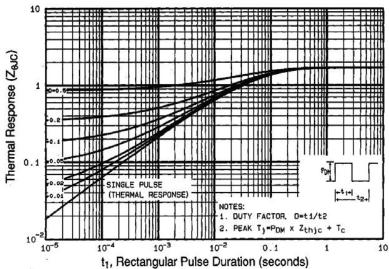


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

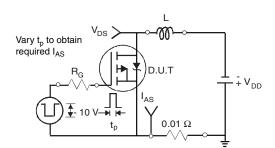


Fig. 12a - Unclamped Inductive Test Circuit

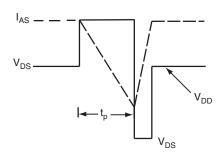


Fig. 12b - Unclamped Inductive Waveforms

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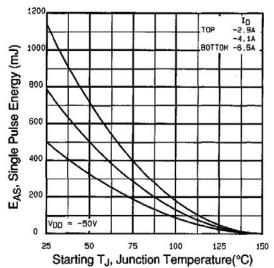


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

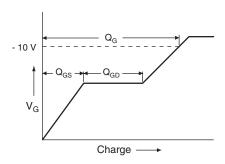


Fig. 13a - Basic Gate Charge Waveform

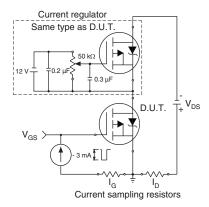
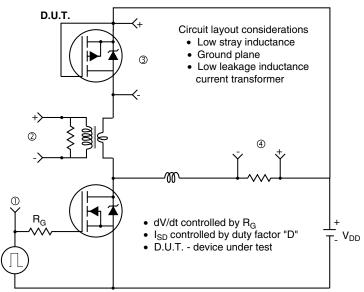


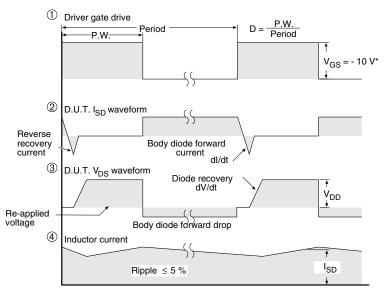
Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver



* V_{GS} = - 5 V for logic level and - 3 V drive devices

Fig. 14 - For P-Channel

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